Onsemi

MOSFET – P-Channel, POWERTRENCH[®]

60 V

FDD5614P

General Description

This 60 V P-Channel MOSFET uses onsemi's high voltage POWERTRENCH process. It has been optimized for power management applications.

Features

- -15 A, -60 V
 - $R_{DS(ON)} = 100 \text{ m}\Omega \text{ at } V_{GS} = -10 \text{ V}$
 - $R_{DS(ON)} = 130 \text{ m}\Omega$ at $V_{GS} = -4.5 \text{ V}$
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low RDS(ON)
- High Power and Current Handling Capability
- This is a Pb-Free Device

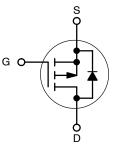
Applications

- DC/DC Converter
- Power Management
- Load Switch

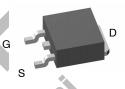
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
VDSS	Drain-Source Voltage	-60	V
Vgss	Gate-Source Voltage	±20	V
Ι _D	Drain Current – Continuous (Note 3) – Pulsed (Note 1a)	-15 -45	A
P _D	Power Dissipation for Single Operation (Note 1) (Note 1a) (Note 1b)	42 3.8 1.6	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



P-Channel MOSFET



DPAK3 (TO-252 3 LD) CASE 369AS

MARKING DIAGRAM



FDD5614P = Specific Device Code \$Y

= onsemi Logo

&Z

&З

&K

- = Assembly Plant Code
- = 3-Digit Date Code
- = 2-Digits Lot Run Traceability Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDD5614P	TO-252-3 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case (Note 1)	3.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1b)	96	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25° C unless otherwise noted)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
DRAIN-SOURCE AVALANCHE RATINGS (Note 1)						
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = -30$ V, $I_D = -4.5$ A	-	-	90	mJ
I _{AR} Maximum Drain-Source Avalanche Current				-	-4.5	A
OFF CHA	OFF CHARACTERISTICS					

OFF CHARACTERISTICS

B _{VDSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = -250 µA	-60	+	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	-	-49	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}$	2	,O,	-1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	0- ,	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	-	_	-100	nA
ON CHAR	ACTERISTICS (Note 2)		A.			

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate to Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	U _1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C	-	4	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	V_{GS} = -10 V, I _D = -4.5 A	-	76	100	mΩ
		V_{GS} = -4.5 V, I _D = -3.9 A	-	99	130	
		V_{GS} = -10 V, I_D = -4.5 A, T_J = 125°C	-	137	185	
I _{D(on)}	On-State Drain Current	V_{GS} = -10 V, V_{DS} = -5 V	-20	-	-	А
9 FS	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -3 A$	-	8	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	759	-	pF
C _{oss}	Output Capacitance	-	90	-	pF
C _{rss}	Reverse Transfer Capacitance	-	39	-	pF

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	V _{DD} = -30 V, I _D = -1 A, V _{GS} = -10 V, R _{GEN} = 6 Ω	-	7	14	ns
t _r	Turn-On Rise Time	$V_{GS} = -10$ V, $H_{GEN} = 0.52$	-	10	20	ns
t _{d(off)}	Turn-Off Delay Time		-	19	34	ns
t _f	Turn-Off Fall Time		-	12	22	ns
Qg	Total Gate Charge	V _{DS} = -30 V, I _D = -4.5 A, V _{GS} = -10 V	-	15	24	nC
Q _{gs}	Gate-Source Charge	$v_{GS} = -10 v$	-	2.5	-	nC
Q _{gd}	Gate-Drain Charge		-	3.0	-	nC

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
DRAIN-SOURCE AVELANCHE RATINGS						
١ _S	Maximum Continuous Drain–Source Diode Forward Current		-	-	-3.2	A
V _{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = –3.2 A (Note 2)	-	-0.8	-1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

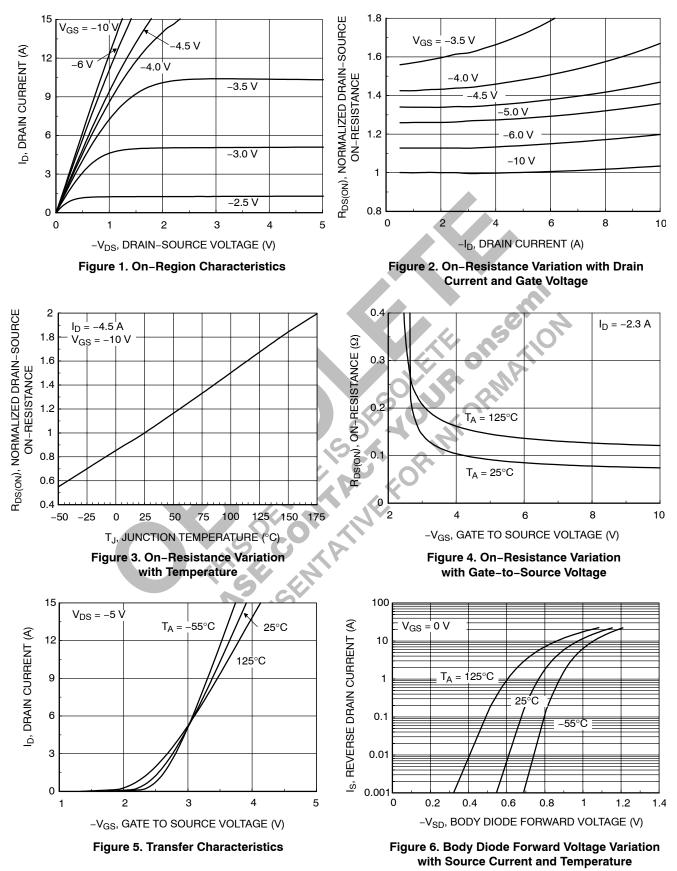
1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

	a) $R_{\theta JA} = 40^{\circ}C/W$ when mounted on a 1 in ² pad of 2 oz copper.	b) R_{θJA} = 96°C/W when mounted on a minimum pad.
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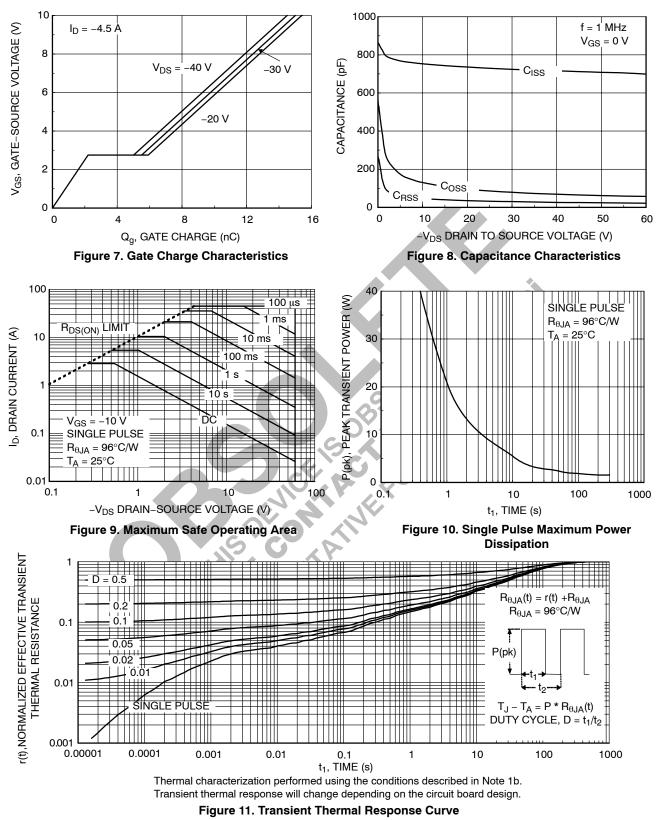
- 2. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%.
- P_D_ 3. Maximum current is calculated as:

Maximum current is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$ where P_D is maximum power dissipation at T_G = 25°C and R_{DS(on)} is at T_{J(max)} and V_{GS} = 10 V. Package current limitation is 21 A.

TYPICAL CHARACTERISTICS

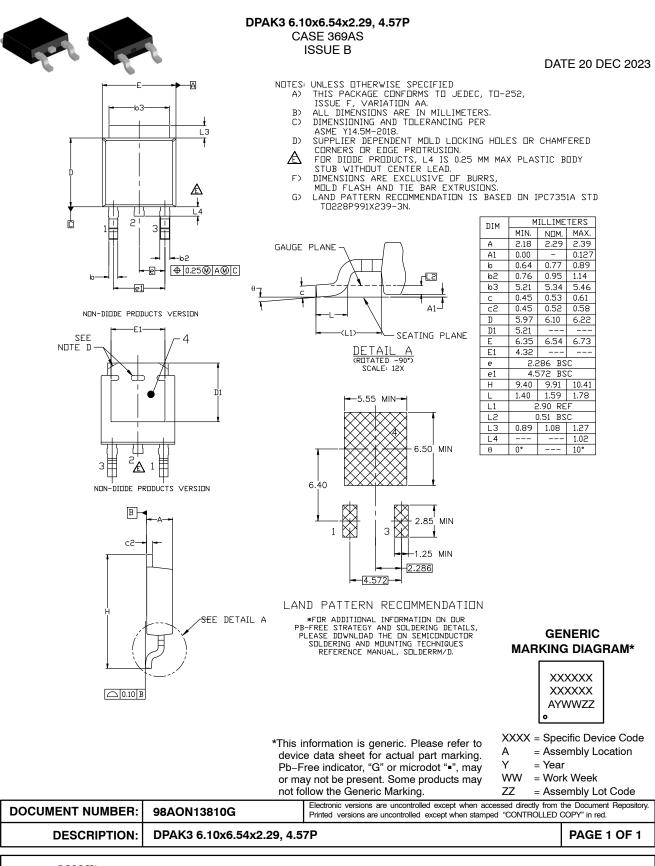


TYPICAL CHARACTERISTICS (continued)



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